

In re the Application of:

NAKAMURA, Yasunori, et al.

Serial No.: 10/629,857 Examiner: William K. Cheung

Filed: July 30, 2003 P.T.O. Confirmation No.: 6154

FOR: POLYPROPYLENE-BASED RESIN COMPOSITION FOR A METALLIZED

FILM, FILM USING THE SAME TO BE SUBJECTED TO METALLIZING

AND METALLIZED FILM USING THE SAME

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated June 27, 2006, please amend the aboveidentified application as set forth below:

Amendments to the Claims begin on page two of this paper.

Remarks begin on page five of this paper.

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Group Art Unit: 1713

Date: September 27, 2006